SDLS161 - OCTOBER 1976 - REVISED MARCH 1988

- 3-State Outputs Drive Bus Lines Directly
- Encodes 8 Data Lines to 3-Line Binary (Octal)
- Applications Include:

   N-Bit Encoding
   Code Converters and Generators
- Typical Data Delay . . . 15 ns
- Typical Power Dissipation . . . 60 mW

#### description

These TTL encoders feature priority decoding of the inputs to ensure that only the highest-order data line is encoded. The 'LS348 circuits encode eight data lines to three-line (4-2-1) binary (octal). Cascading circuitry (enable input E1 and enable output E0) has been provided to allow octal expansion. Outputs A0, A1, and A2 are implemented in three-state logic for easy expansion up to 64 lines without the need for external circuitry. See Typical Application Data.

#### **FUNCTION TABLE**

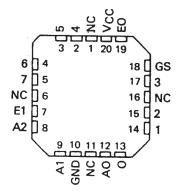
INPUTS							Ol	JTPU	TS				
EI	0	1	2	3	4	5	6	7	A2	A1	AO	GS	EO
Н	Х	Х	Х	Х	Χ	X	X	X	Z	Z	Z	Н	Н
L	Н	Н	Н	Н	Н	Н	Н	Н	z	Z	Z	н	L
L	Х	Χ	Х	Х	Х	Χ	Х	L	L	L	L	L	н
L	Х	Х	Χ	Х	Х	Х	L	Н	L	L	Н	L	н
L	Х	Х	Χ	Χ	Х	L	Н	Н	L	Н	L	L	н
L	Х	Х	Х	Х	L	Н	Н	Н	L	Н	Н	L	н
L	Ϋ́	Х	Х	L	Н	Н	Н	Н	н	L	L	L	н
L	Х	Х	L	Н	Н	Н	Н	Н	н	L	н	L	н
L	X	L	Н	H	Н	Н	Н	Н	н	Н	L	L	н
L	L	Н	Н	Н	H	Н	Н	Н	Н	Н	Н	L	н

H = high logic level, L = low logic level, X = irrelevant

SN54LS348 . . . J OR W PACKAGE SN74LS348 . . . D OR N PACKAGE (TOP VIEW)

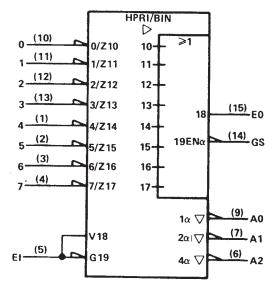
4 □1	U <sub>16</sub>	Vcc
5 □2	15	] EO
6 🏻 3	14	GS
7 🛮 4	13	]3
E1 🛛 5	12	]2
A2 [] 6	11	] 1
A1 □7	10	] o
GND [[8	9	] AO

# SN54LS348 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

# logic symbol<sup>†</sup>



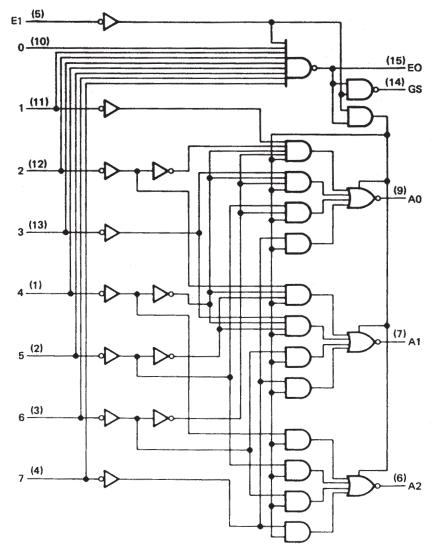
<sup>&</sup>lt;sup>†</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.



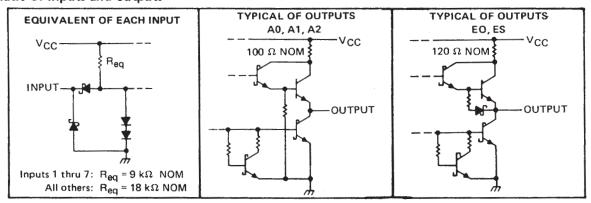
Z = high-impedance state

#### logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

#### schematic of inputs and outputs





SDLS161 - OCTOBER 1976 - REVISED MARCH 1988

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	
Operating free-air temperature range	SN54LS348
	SN74LS348
Storage temperature range	

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

	·	SI	<b>N54LS</b> 3	48	SN74LS348			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>	gh-level output current, IOH					5	5,25	V
High-level output outront Love	A0, A1, A2			-1			-2.6	mA
migriever output current, 10H	EO, GS			-400			-400	μА
Low-level output current, IOI	A0, A1, A2			12			24	mA
- Converse of the Content to C	EO, GS			4			8	mA
Operating free-air temperature, TA		-55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CON	SN54LS348			SN74LS348			4 15 11 =		
			TEST CON	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
VIH High-level input voltage					2			2			٧
VIL Low-level input voltage						**	0.7			0.8	V
ViK	Input clamp voltage		V <sub>CC</sub> = MIN,	I <sub>1</sub> = -18 mA			-1.5			-1.5	٧
VOH	High-level	A0, A1, A2	V <sub>CC</sub> = MIN,	I <sub>OH</sub> = -1 mA	2.4	3.1					
	output voltage	A0, A1, A2	V <sub>!H</sub> = 2 V,	I <sub>OH</sub> = -2.6 mA				2.4	3,1		V
		EO, GS	V <sub>IL</sub> = V <sub>IL</sub> max	$I_{OH} = -400 \mu A$	2.5	3.4		2.7	3.4		1
VOL	Low-level Output voltage	A0, A1, A2	V <sub>CC</sub> = MIN,	I <sub>OL</sub> = 12 mA		0.25	0.4		0.25	0.4	
		70,71,72	V <sub>IH</sub> = 2 V,	OL = 24 mA					0,35	0.5	,,
*OL		EO, GS	VIL = VILmax	<sup>1</sup> OL = 4 mA		0.25	0.4		0.25	0.4	4
				IOL = 8 mA					0.35	0.5	
loz	Off-State (high-impedance	A0, A1, A2	V <sub>CC</sub> = MAX,	V <sub>O</sub> = 2.7 V			20		******	20	
.02	state) output current		V <sub>IH</sub> = 2 V	V <sub>O</sub> = 0.4 V			-20			-20	μΑ
l <sub>1</sub>	Input current at maximum	Inputs 1 thru 7	V <sub>CC</sub> = MAX,				0.2			0,2	_
'1	input voltage	All other inputs	VCC = MAX,	V  = / V			0.1			0.1	mA
Ιн	High-level input current	Inputs 1 thru 7	V MAY				40			40	
'1H	riigitiever triput current	All other inputs	V <sub>CC</sub> = MAX,	V  = 2.7 V			20			20	μΑ
HL	Low-level input current	Inputs 1 thru 7	V 144.V				-0.8			-0.8	
'1L	Low-level input current	All other inputs	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V			-0.4			-0.4	mA
los	Short-circuit output current §	Outputs A0, A1, A2	.,		-30		-130	-30		-130	
.08	onorcanduri output currents	Outputs EO, GS	V <sub>CC</sub> = MAX		-20		-100	-20		-100	mA
lcc	Supply current		V <sub>CC</sub> = MAX,	Condition 1		13	25		13	25	
100	Supply culterit		See Note 2	Condition 2		12	23		12	23	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: ICC (condition 1) is measured with inputs 7 and EI grounded, other inputs and outputs open. ICC (condition 2) is measured with all inputs and outputs open.



<sup>\$</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ} \text{ C}$ .

<sup>§</sup>Not more than one output should be shorted at a time.

SDLS161 - OCTOBER 1976 - REVISED MARCH 1988

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ} \text{ C}$

PARAMETER <sup>†</sup>	FROM (INPUT)	TO (OUTPUT)	WAVEFORM	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ФLН	1 thru 7	A0, A1, or A2	In-phase		111	11	17	ns
tPHL.	1 11114 /	A0, A1, 01 A2	output	C. = 45 = 5		20	30	115
ФLН	1 thru 7	A0, A1, or A2	Out-of-phase	CL = 45 pF,		23	35	ns
<b>tPHL</b>	i thru /	AU, A1, 01 A2	output	RL = 667 Ω, See Note 3		23	35	INS
ФZH	EI	A0, A1, or A2		See Note 3		25	39	ns
ΨZL	] '	70, 71, 01 72				24	41	] ""
<b>tPLH</b>	0 thru 7	EO GS	Out-of-phase	C <sub>L</sub> = 15 pF R <sub>L</sub> = 2 kΩ, See Note 3		11	18	ns
<b>tPHL</b>			output			26	40	
<b>tPLH</b>			In-phase			38	55	ns
tPHL	O and /		output			9	21	1 ""
<b>tPLH</b>	EI	EI GS	In-phase			11	17	
<b>tPHL</b>	1	43	output			14	36	ns
ФLН	EI	EO	In-phase			17	26	
tPHL	-		output	:		25	40	ns
tPHZ	EI	A0, A1, or A2		CL = 5 pF		18	27	
ヤLZ	] -'	70, 71, 01 72		R <sub>L</sub> = 667 Ω		23	35	ns

<sup>†</sup> tpLH = propagation delay time, low-to-high-level output

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

# TYPICAL APPLICATION DATA

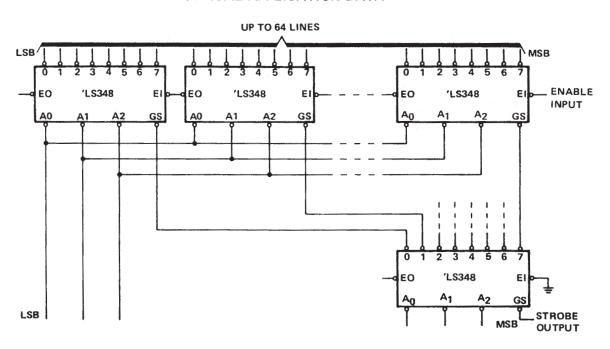


FIGURE 1-PRIORITY ENCODER WITH UP TO 64 INPUTS.



tpHL = propagation delay time, high-to-low-level output

tpzH = output enable time to high level

tpzL = output enable time to low level

tpHZ = output disable time from high level

tpLZ = output disable time from low level

#### **IMPORTANT NOTICE**

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.

Copyright © 1999, Texas Instruments Incorporated